



Datasheet

40 A standard Triacs in TOP3 package



TOP3 Insulated



Product status link
TPDV640RG
TPDV840RG
TPDV1240RG

Product summary		
I _{T(RMS)}	40 A	
V _{DRM} /V _{RRM}	TPDV640RG: 600 V	
	TPDV840RG: 800 V	
	TPDV1240RG: 1200 V	
I _{GT}	200 mA	

Features

- On-state current (I_{T(RMS)}): 40 A
- Max. blocking voltage (V_{DRM}/V_{RRM}): 1200 V
- Gate current (I_{GT}): 200 mA
- Commutation at 10 V/µs: up to 142 A/ms
- Noise immunity: 500 V/µs
- Insulated package:
 - 2500 V rms (UL recognized: E81734)

Application

- Motor control
- Induction motor speed control

Description

The TPDVxx40 series use high performance alternistor technology.

Featuring very high commutation levels and high surge current capability, this family is well adapted to power control for inductive loads (motor, transformer...).



1 Characteristics

Symbol	Parameters Va					
I _{T(RMS)}	RMS on-state current (180° conduction angle)	T _c = 75 °C	40	А		
		t _p = 2.5 ms		590		
I _{TSM}	Non repetitive surge peak on-state current	t _p = 8.3 ms	T _j = 25 °C	370	Α	
		t _p = 10 ms	_	250		
l ² t	I ² t value for fusing	t _p = 10 ms	T _j = 25 °C	610	A ² s	
di/dt	Critical rate of rise of on-state current	Repetitive f = 5	Repetitive f = 50 Hz		A/µs	
ai/at	$I_G = 500 \text{ mA}, \text{ dI}_G/\text{dt} = 1 \text{ A}/\mu\text{s}$	Non repetitive	Non repetitive			
		TPDV640		600	V	
V _{DRM} , V _{RRM}	Repetitive surge peak off-state voltage	TPDV840	T _j = 125 °C	800		
		TPDV1240		1200		
I _{GM}	Peak gate current	8	А			
P _{GM}	Peak gate power dissipation	40	W			
V _{GM}	Peak positive gate voltage			16	V	
P _{G(AV)}	Average gate power dissipation	1	W			
T _{stg}	Storage junction temperature range	-40 to +150	°C			
Tj	Operating junction temperature range	-40 to +125	°C			
TL	Maximum lead temperature for soldering during	260	°C			
V _{INS} ⁽¹⁾	Insulation RMS voltage, 1 minute 250					

1. A1, A2, gate terminals to case for 1 minute.

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Parameters Quadrant			Value	Unit
I _{GT}	$V_{-} = 12 V_{-} P_{-} = 23 O_{-}$	1 - 11 - 111	Max.	200	mA
V _{GT}	$V_{\rm D} = 12$ V, $K_{\rm L} = 33$ M	1 - 11 - 111	Max.	1.5	V
V _{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 125 \text{ °C}$	1 - 11 - 111	Min.	0.2	V
t _{GT}	$V_D = V_{DRM}$, $I_G = 500$ mA, $dI_G/dt = 3$ A/µs	1 - 11 - 111	Тур.	2.5	μs
I _H ⁽¹⁾	I _T = 500 mA		Тур.	50	mA
.	lo = 12 lor	1 - 111	Typ.100Typ.200	mΑ	
۲ <u>ـ</u>		II		200	ША
dV/dt	V_D = 67 % V_{DRM} gate open, T_j = 125 °C		Min.	500	V/µs
V _{TM} ⁽¹⁾	I _{TM} = 56 A, t _p = 380 μs		Max.	1.8	V
I _{DRM} /I _{RRM}		T _j = 25 °C	Мох	20	μA
	VDRM - VRRM	T _j = 125 °C	iviax.	8	mA
(dl/dt)c ⁽¹⁾	(dl/dt)c = 200 A/ms, T _j = 125 °C			35	A/ms
	(dl/dt)c = 10 A/ms, T _j = 125 °C			142	

1. For both polarities of A2 referenced to A1

Table 3. Thermal resistance

Symbol	Parameters	Value	Unit
R	Junction to case (DC)	1.2	
l∿th(j-c)	Junction to case (AC) for 360 $^{\circ}$ conduction angle (f = 50 Hz)	0.9	°C/W
R _{th(j-a)}	Junction to ambient	50	



1.1 Characteristics (curves)



Figure 2. Max. rms power dissipation and max. allowable temperatures (T_{amb} and T_{case}) for various R_{th}





Figure 4. Relative variation of thermal impedance versus pulse duration











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Figure 9. Safe operating area below curve





2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 Package information

- ECOPACK (lead-free plating and halogen free package compliance)
- Lead-free package leads finishing
- Halogen-free molding compound resin meets UL94 standard level V0
- Recommended torque: 1.05 N·m (max. torque: 1.2 N·m)



Figure 10. Package outline

				Dimensions		
Ref.		mm			Inches ⁽¹⁾	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.40		4.60	0.1732		0.1811
В	1.45		1.55	0.0571		0.0610
С	14.35		15.60	0.5650		0.6142
D	0.50		0.70	0.0197		0.0276
E	2.70		2.90	0.1063		0.1142
F	15.80		16.50	0.6220		0.6496
G	20.40		21.10	0.8031		0.8307
Н	15.10		15.50	0.5945		0.6102
J	5.40		5.65	0.2126		0.2224
К	3.40		3.65	0.1339		0.1437
L	4.08		4.17	0.1606		0.1642
Р	1.10		1.30	0.0430		0.0510
R		4.60			0.1811	

1. Inches given for reference only



3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TPDV640RG	TPDV640				
TPDV840RG	TPDV840	TOP3 Ins.	ns. 4.5 g	30	Tube
TPDV1240RG	TPDV1240				

Revision history

Table 6. Document revision history

Date	Revision	Changes
30-Mar-2011	1	Initial release.
		Updated Table 3.
10-Jun-2015	2	Updated Figure 9.
		Format updated to current standard.
06-Oct-2023	3	Updated Section 2.1 Package information.

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